Power MOSFET 2 Amps, 20 Volts P-Channel TSOP-6

Features

- Ultra Low R_{DS(on)}
- Higher Efficiency Extending Battery Life
- Miniature TSOP6 Surface Mount Package
- Pb–Free Package May be Available. The G–Suffix Denotes a Pb–Free Lead Finish

Applications

• Power Management in Portable and Battery–Powered Products, i.e.: Cellular and Cordless Telephones, and PCMCIA Cards

MAXIMUM RATINGS (T_J = 25° C unless otherwise noted)

Rating	Symbol	Value	Unit
Drain-to-Source Voltage	V _{DSS}	-20	Volts
Gate-to-Source Voltage - Continuous	V _{GS}	±12	Volts
Thermal Resistance Junction–to–Ambient (Note 1) Total Power Dissipation @ $T_A = 25^{\circ}C$ Drain Current – Continuous @ $T_A = 25^{\circ}C$ – Pulsed Drain Current ($T_p < 10 \ \mu$ S)	R _{θJA} P _d I _D I _{DM}	244 0.5 –2.2 –10	°C/W Watts Amps Amps
Thermal Resistance Junction–to–Ambient (Note 2) Total Power Dissipation @ $T_A = 25^{\circ}C$ Drain Current – Continuous @ $T_A = 25^{\circ}C$ – Pulsed Drain Current ($T_p < 10 \ \mu$ S)	R _{θJA} P _d I _D I _{DM}	128 1.0 -3.1 -14	°C/W Watts Amps Amps
Thermal Resistance Junction-to-Ambient (Note 3) Total Power Dissipation @ $T_A = 25^{\circ}C$ Drain Current – Continuous @ $T_A = 25^{\circ}C$ – Pulsed Drain Current ($T_p < 10 \mu S$)	R _{θJA} P _d I _D I _{DM}	62.5 2.0 -4.4 -20	°C/W Watts Amps Amps
Operating and Storage Temperature Range	T _J , T _{stg}	–55 to 150	°C
Maximum Lead Temperature for Soldering Purposes for 10 Seconds	ΤL	260	°C

1. Minimum FR-4 or G-10PCB, operating to steady state.

 Mounted onto a 2 in square FR-4 board (1" sq. 2 oz. cu. 0.06" thick single sided), operating to steady state.

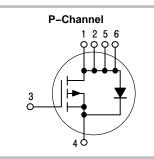
 Mounted onto a 2 in square FR-4 board (1" sq. 2 oz. cu. 0.06" thick single sided), t < 5.0 seconds.

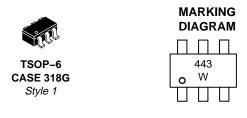


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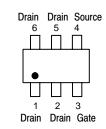
2 AMPERES 20 VOLTS R_{DS(on)} = 65 mΩ





443 = Device Code W = Work Week

PIN ASSIGNMENT



ORDERING INFORMATION

Device	Package	Shipping [†]	
NTGS3443T1	TSOP-6	3000 Tape & Reel	
NTGS3443T1G	TSOP-6	3000 Tape & Reel	

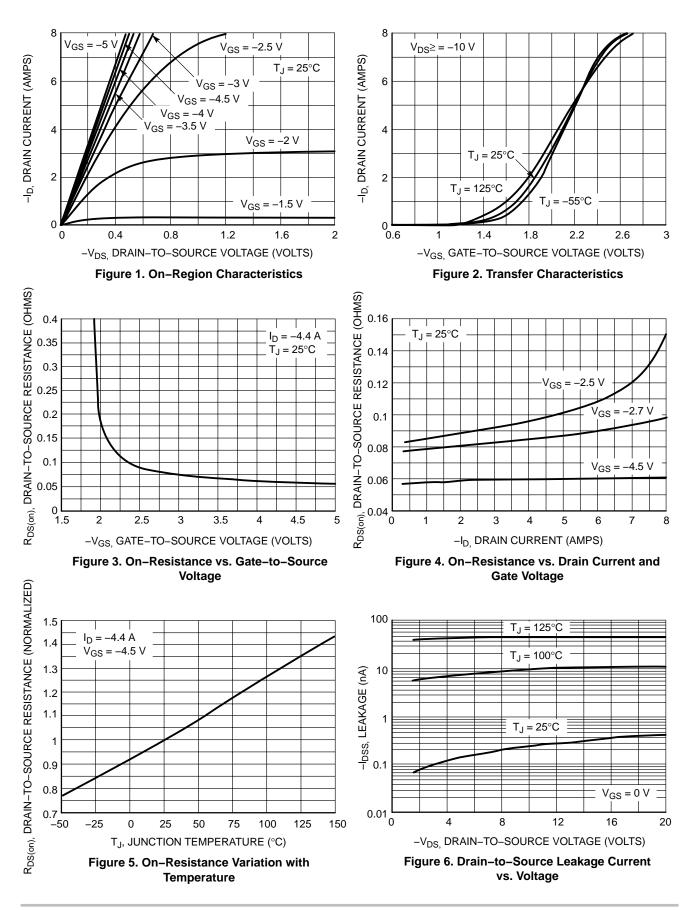
⁺For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

ELECTRICAL CHARACTERISTICS ($T_A = 25^{\circ}C$ unless otherwise noted) (Notes 4 & 5)

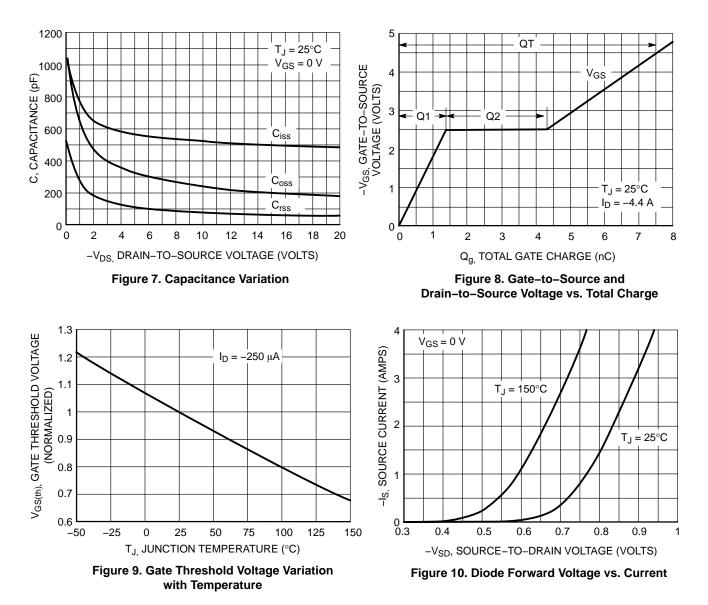
Cha	Symbol	Min	Тур	Max	Unit	
OFF CHARACTERISTICS						
Drain–Source Breakdown Voltage ($V_{GS} = 0 \text{ Vdc}, I_D = -10 \mu A$)		V _{(BR)DSS}	-20	-	_	Vdc
Zero Gate Voltage Drain Current ($V_{GS} = 0 \text{ Vdc}, V_{DS} = -20 \text{ Vdc}, T_J = 25^{\circ}\text{C}$) ($V_{GS} = 0 \text{ Vdc}, V_{DS} = -20 \text{ Vdc}, T_J = 70^{\circ}\text{C}$)		I _{DSS}			-1.0 -5.0	μAdc
Gate-Body Leakage Current ($V_{GS} = -12 Vdc, V_{DS} = 0 Vdc$)		I _{GSS}	-	-	-100	nAdc
Gate-Body Leakage Current (V _{GS} = +12 Vdc, V _{DS} = 0 Vdc)		I _{GSS}	-	_	100	nAdc
ON CHARACTERISTICS						
Gate Threshold Voltage ($V_{DS} = V_{GS}$, $I_D = -250 \ \mu Adc$)		V _{GS(th)}	-0.60	-0.95	-1.50	Vdc
$\begin{array}{l} \mbox{Static Drain-Source On-State Res} \\ (V_{GS} = -4.5 \mbox{ Vdc}, \mbox{I}_D = -4.4 \mbox{ Adc}) \\ (V_{GS} = -2.7 \mbox{ Vdc}, \mbox{I}_D = -3.7 \mbox{ Adc}) \\ (V_{GS} = -2.5 \mbox{ Vdc}, \mbox{I}_D = -3.5 \mbox{ Adc}) \end{array}$	sistance	R _{DS(on)}		0.058 0.082 0.092	0.065 0.090 0.100	Ω
Forward Transconductance $(V_{DS} = -10 \text{ Vdc}, I_D = -4.4 \text{ Adc})$		9 FS	_	8.8	_	mhos
DYNAMIC CHARACTERISTICS			•			
Input Capacitance		C _{iss}	-	565	-	pF
Output Capacitance	(V _{DS} = -5.0 Vdc, V _{GS} = 0 Vdc, f = 1.0 MHz)	C _{oss}	-	320	-	pF
Reverse Transfer Capacitance		C _{rss}	-	120	-	pF
SWITCHING CHARACTERISTICS	3	•	•			
Turn-On Delay Time		t _{d(on)}	-	10	25	ns
Rise Time	(V _{DD} = −20 Vdc, I _D = −1.0 Adc,	t _r	-	18	45	ns
Turn-Off Delay Time	$V_{GS} = -4.5 \text{ Vdc}, R_{g} = 6.0 \Omega$	t _{d(off)}	-	30	50	ns
Fall Time		t _f	-	31	50	ns
Total Gate Charge		Q _{tot}	-	7.5	15	nC
Gate-Source Charge	$(V_{DS} = -10 \text{ Vdc}, V_{GS} = -4.5 \text{ Vdc},$ $I_D = -4.4 \text{ Adc})$	Q _{gs}	-	1.4	-	nC
Gate-Drain Charge		Q _{gd}	-	2.9	-	nC
BODY-DRAIN DIODE RATINGS						
Diode Forward On–Voltage	$(I_S = -1.7 \text{ Adc}, V_{GS} = 0 \text{ Vdc})$	V _{SD}	-	-0.83	-1.2	Vdc
Reverse Recovery Time	$(I_S = -1.7 \text{ Adc}, dI_S/dt = 100 \text{ A/}\mu\text{s})$	t _{rr}	-	30	-	ns

Indicates Pulse Test: P.W. = 300 μsec max, Duty Cycle = 2%.
Handling precautions to protect against electrostatic discharge is mandatory.

TYPICAL ELECTRICAL CHARACTERISTICS



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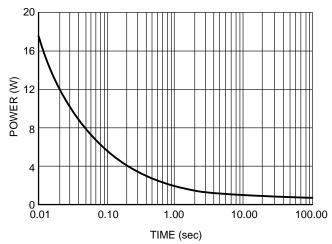


Figure 11. Single Pulse Power

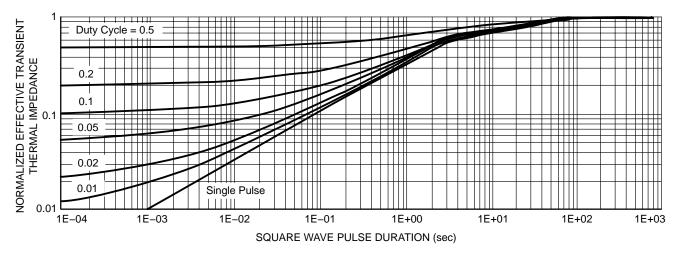
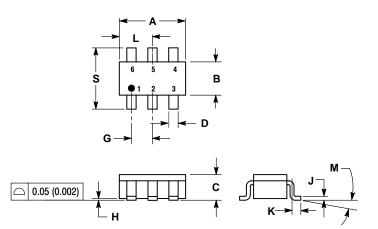


Figure 12. Normalized Thermal Transient Impedance, Junction-to-Ambient

PACKAGE DIMENSIONS

TSOP-6 CASE 318G-02 ISSUE K



NOTES

- 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982. CONTROLLING DIMENSION: MILLIMETER.
- 2. MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH THICKNESS. MINIMUM LEAD 3. THICKNESS IS THE MINIMUM THICKNESS
- OF BASE MATERIAL. DIMENSIONS A AND B DO NOT INCLUDE MOLD FLASH, PROTRUSIONS, OR GATE 4 BURRS.

	MILLIMETERS		INCHES	
DIM	MIN	MAX	MIN	MAX
Α	2.90	3.10	0.1142	0.1220
В	1.30	1.70	0.0512	0.0669
С	0.90	1.10	0.0354	0.0433
D	0.25	0.50	0.0098	0.0197
G	0.85	1.05	0.0335	0.0413
н	0.013	0.100	0.0005	0.0040
J	0.10	0.26	0.0040	0.0102
κ	0.20	0.60	0.0079	0.0236
L	1.25	1.55	0.0493	0.0610
М	0	10	0	10
S	2.50	3.00	0.0985	0.1181

STYLE 1: PIN 1. DRAIN 2. DRAIN

3. GATE

SOLDERING FOOTPRINT*

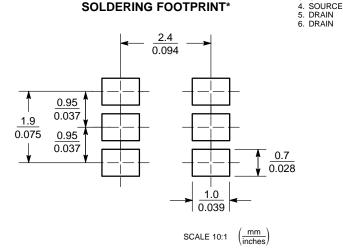


Figure 13. TSOP-6

*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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